

ON Semiconductor®

FCA20N60S / FCA20N60S-F109

600V N-Channel MOSFET

Features

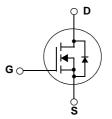
- 650V @T_J = 150°C
- Typ. Rds(on)= 0.22Ω
- Ultra low gate charge (typ. Qg=55nC)
- Low effective output capacitance (typ. Coss.eff=110pF)
- 100% avalanche tested

Description

SuperFETTM is, ON Semiconductor's proprietary, new generation of high voltage MOSFET family that is utilizing an advanced charge balance mechanism for outstanding low on-resistance and lower gate charge performance.

This advanced technology has been tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate and higher avalanche energy. Consequently, SuperFET is very suitable for various AC/DC power conversion in switching mode operation for system miniaturization and higher efficiency.





Absolute Maximum Ratings

Symbol	Parameter		FCA20N60S	Unit	
V _{DSS}	Drain-Source Voltage		600	V	
I _D	Drain Current - Continuous - Continuous	(T _C = 25°C) (T _C = 100°C)	20 12.7	A A	
I _{DM}	Drain Current - Pulsed	(Note 1)	60	A	
V _{GSS}	Gate-Source voltage		± 30	V	
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		450	mJ	
I _{AR}	Avalanche Current	(Note 1)	20	А	
E _{AR}	Repetitive Avalanche Energy	(Note 1)	26	mJ	
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	4.5	V/ns	
P _D	Power Dissipation (T _C = 25°C) - Derate above 25°C		260 2.1	W W/°C	
T _{J,} T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C	
T _L	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds		300	°C	

^{*}Drain current limited by maximum junction temperature

Thermal Characteristics

Symbol	Parameter	FCA20N60S	Unit	
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	0.48	°C/W	
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	41.7	°C/W	

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FCA20N60S	FCA20N60S	TO-3P	-	-	30
FCA20N60S	FCA20N60S-F109	TO-3PN	-	-	30

Electrical Characteristics $T_C = 25$ °C unless otherwise noted

Symbol	Parameter	Conditions	Min	Тур	Max	Units
Off Charac	teristics	-		!		
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 250\mu A, T_J = 25^{\circ}C$	600			V
		$V_{GS} = 0V, I_D = 250\mu A, T_J = 150^{\circ}C$		650		V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient	I _D = 250μA, Referenced to 25°C		0.6		V/°C
BV _{DS}	Drain-Source Avalanche Breakdown Voltage	$V_{GS} = 0V, I_{D} = 20A$		700		V
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 600V, V_{GS} = 0V$ $V_{DS} = 480V, T_{C} = 125^{\circ}C$			1 10	μ Α μ Α
I _{GSSF}	Gate-Body Leakage Current, Forward	$V_{GS} = 30V, V_{DS} = 0V$			100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	$V_{GS} = -30V$, $V_{DS} = 0V$			-100	nA
On Charac	teristics					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	3.0		5.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 10V, I _D = 10A		0.22	0.26	Ω
9 _{FS}	Forward Transconductance	V _{DS} = 40V, I _D = 10A (Note 4)		11.5		S
Dynamic C	haracteristics					
C _{iss}	Input Capacitance	$V_{DS} = 25V$, $V_{GS} = 0V$,		1730	2250	pF
C _{oss}	Output Capacitance	f = 1.0MHz		960	1150	pF
C _{rss}	Reverse Transfer Capacitance			85		pF
C _{oss}	Output Capacitance	$V_{DS} = 480V, V_{GS} = 0V, f = 1.0MHz$		45	60	pF
Coss eff.	Effective Output Capacitance	$V_{DS} = 0V$ to 400V, $V_{GS} = 0V$		110		pF
Switching	Characteristics					
t _{d(on)}	Turn-On Delay Time	$V_{DD} = 300V, I_D = 20A$		46	90	ns
t _r	Turn-On Rise Time	$R_G = 25\Omega$		140	280	ns
t _{d(off)}	Turn-Off Delay Time			175	350	ns
t _f	Turn-Off Fall Time	(Note 4, 5)		100	200	ns
Qg	Total Gate Charge	V _{DS} = 480V, I _D = 20A		57	72	nC
Q_{gs}	Gate-Source Charge	V _{GS} = 10V		11.5	14	nC
Q_{gd}	Gate-Drain Charge	(Note 4, 5)		28		nC
Drain-Sour	ce Diode Characteristics and Maximun	n Ratings				•
I _S	Maximum Continuous Drain-Source Diode Forward Current				20	Α
I _{SM}	Maximum Pulsed Drain-Source Diode Fo	ed Drain-Source Diode Forward Current			60	Α
V_{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0V, I _S = 20A			1.4	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0V, I _S = 20A		450		ns
Q _{rr}	Reverse Recovery Charge	$dI_F/dt = 100A/\mu s $ (Note 4)		8.2		μС

NOTES

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature
- 2. I_{AS} = 8A, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25 $^{\circ}C$
- 3. $I_{SD} \le 20A$, di/dt $\le 200A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25^{\circ}C$
- 4. Pulse Test: Pulse width $\leq 300 \mu s, \, \text{Duty Cycle} \leq 2\%$
- 5. Essentially Independent of Operating Temperature Typical Characteristics

Typical Performance Characteristics

Figure 1. On-Region Characteristics

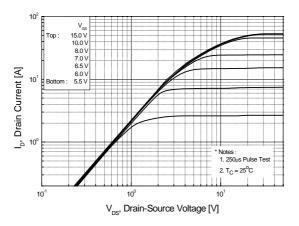


Figure 3. On-Resistance Variation vs.
Drain Current and Gate Voltage

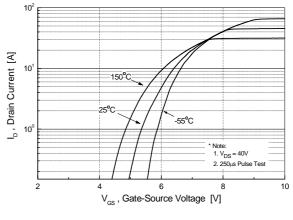


Figure 2. Transfer Characteristics

Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperatue

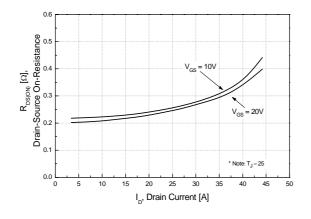
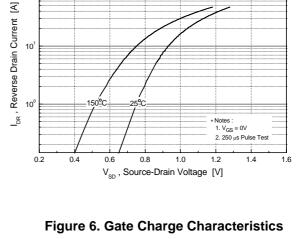
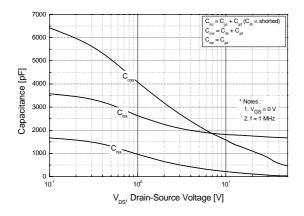
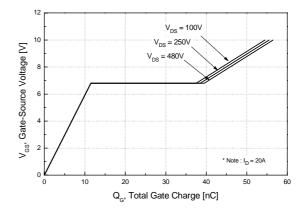


Figure 5. Capacitance Characteristics







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Typical Performance Characteristics (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

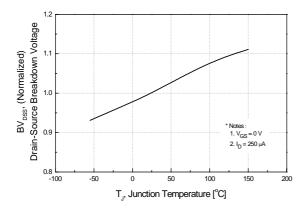


Figure 9. Maximum Safe Operating Area

Figure 8. On-Resistance Variation vs. Temperature

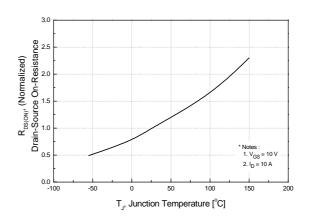
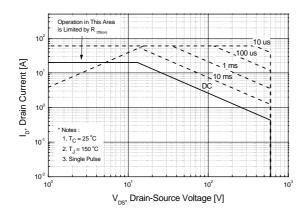
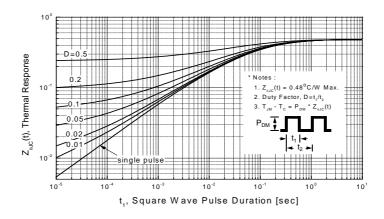


Figure 10. Maximum Drain Current vs. Case Temperature

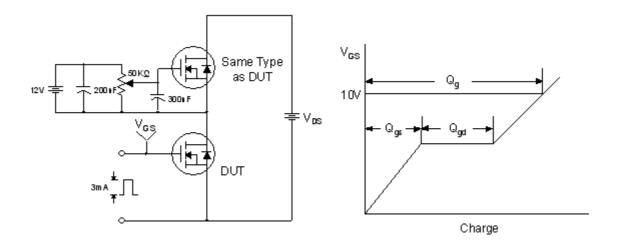


25 20 V train 15 0 25 50 75 100 125 150 T_C, Case Temperature [°C]

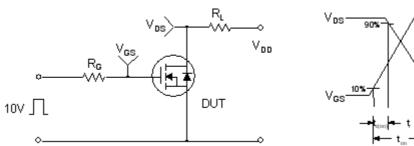
Figure 11. Transient Thermal Response Curve



Gate Charge Test Circuit & Waveform

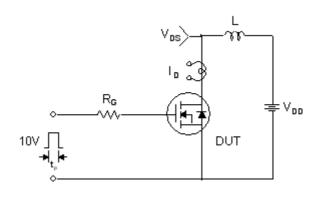


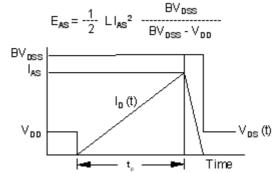
Resistive Switching Test Circuit & Waveforms



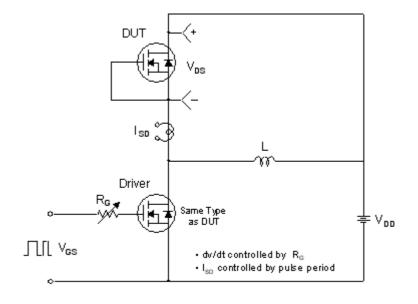
V_{GS} 10%

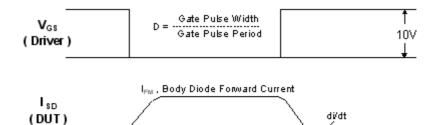
Unclamped Inductive Switching Test Circuit & Waveforms

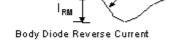


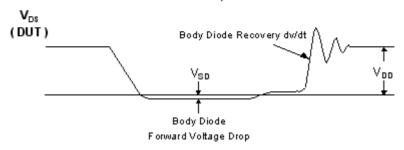


Peak Diode Recovery dv/dt Test Circuit & Waveforms



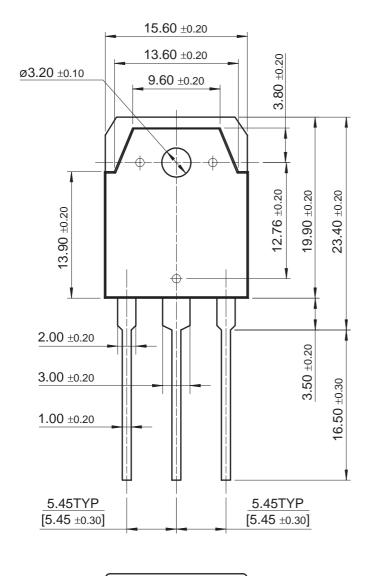


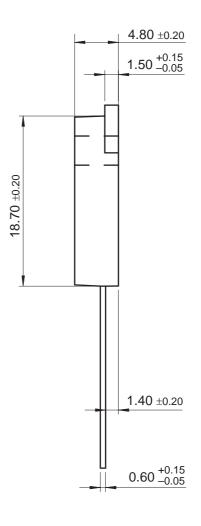




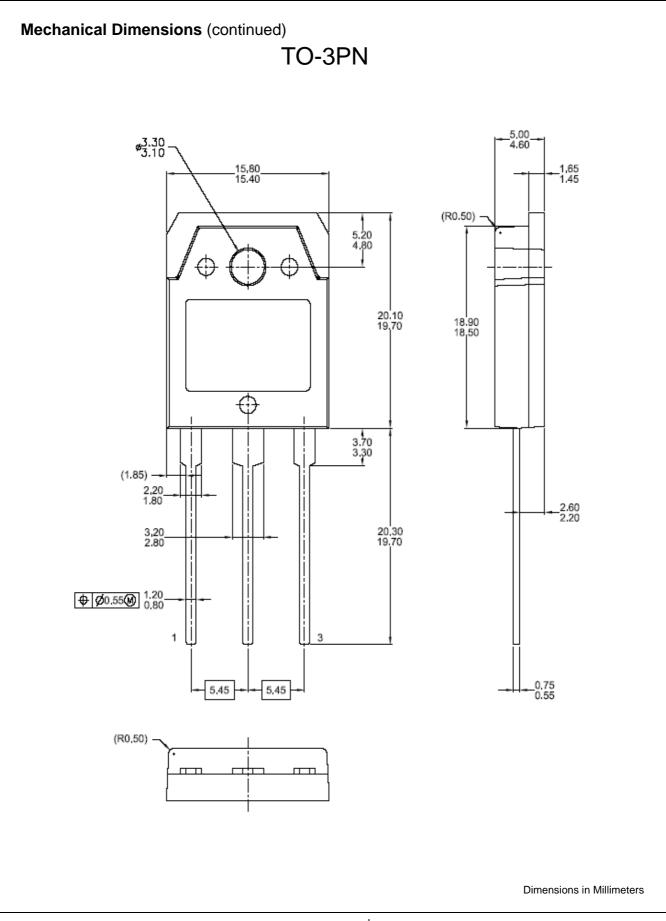
Mechanical Dimensions

TO-3P





Dimensions in Millimeters



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